# Switch-mode Power Rectifier

# MUR550APFG, MURD550PFG, MUR550PFG, MURF550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01

These state-of-the-art devices are designed for power factor correction in discontinuous and critical conduction mode.

#### Features

- 520 V Rating Meets 80% Derating Requirements of Major OEMs
- Low Forward Voltage Drop
- Low Leakage
- Ultrafast 95 Nanosecond Recovery Time
- Reduces Forward Conduction Loss
- NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

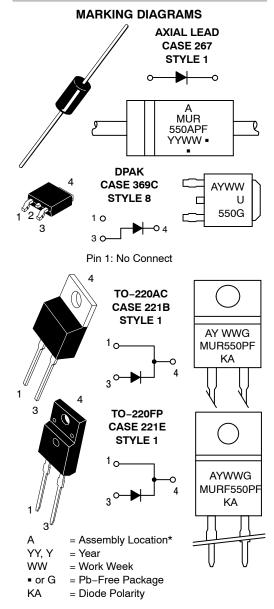
- DCM PFC Designs
- Switching Power Supplies
- Power Inverters
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: MUR550APFG: 1.1 Gram (Approximately) MURD550PFG, NRVUD550PFT4G, NRVUD550PFT4G–VF01: 0.4 Gram (Approximately) MUR550PFG, MURF550PFG: 1.9 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



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# ULTRAFAST RECTIFIER 5.0 AMPERES, 520 VOLTS



\*The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

| Device              | Package               | Shipping <sup>†</sup> |
|---------------------|-----------------------|-----------------------|
| MUR550APFG          | Axial                 | 500 Units/Bag         |
| MUR550APFRLG        | Axial                 | 1,500 Tape & Reel     |
| MURD550PFT4G        | DPAK<br>(Pb-Free)     | 2,500 Tape & Reel     |
| NRVUD550PFT4G*      | DPAK<br>(Pb-Free)     | 2,500 Tape & Reel     |
| NRVUD550PFT4G-VF01* | DPAK<br>(Pb–Free)     | 50 Units / Rail       |
| MUR550PFG           | TO-220AC<br>(Pb-Free) | 50 Units / Rail       |
| MURF550PFG          | TO-220FP<br>(Pb-Free) | 50 Units / Rail       |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

\*NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

#### MAXIMUM RATINGS

| Rating   | Symbol   | Value           | Unit |
|--|--|-----------------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage   | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 520             | V    |
| Average Rectified Forward Current<br>(Rated $V_R$ ) $T_C = 65^{\circ}C$ MUR550APFG, NRVUD550PFT4G-VF01<br>MURD550PFG, NRVUD550PFT4G,<br>MURD550PFG, MURF550PFG, MURF550PFG         | I <sub>F(AV)</sub>                                     | 5.0<br>5.0      | A    |
| Non-Repetitive Peak Surge Current<br>(Surge Applied at Rated Load Conditions Halfwave, 60 Hz) MUR550APFG<br>NRVUD550PFT4G, NRVUD550PFT4G-VF01, MURD550PFG<br>MUR550PFG, MURF550PFG | I <sub>FSM</sub>                                       | 85<br>75<br>100 | A    |
| Operating Junction Temperature Range   | ТJ   | -65 to +175     | °C   |
| Storage Temperature Range  | T <sub>stg</sub>                                       | -65 to +175     | °C   |
| ESD Ratings: Machine Model = C<br>Human Body Model = 3B  | ESD  | > 400<br>> 8000 | V    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

| Characteristic   | Symbol           | Value              | Unit |
|--|------------------|--------------------|------|
| Thermal Resistance, Junction-to-Case (Note 1)<br>MURD550PG, MUR550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01<br>MURF550PFG         | R <sub>θJC</sub> | 2.8<br>5.75        | °C/W |
| Thermal Resistance, Junction-to-Ambient<br>MUR550APFG<br>NRVUD550PFT4G, NRVUD550PFT4G-VF01, MURD550PFG (Note 3),<br>MURF550PFG | $R_{	heta JA}$   | Note 2<br>62<br>75 | °C/W |

1. Rating applies when surface mounted on the minimum pad sizes recommended.

2. See Note 2, Ambient Mounting Data.

3. 1 inch square pad size on FR4 board.

### **ELECTRICAL CHARACTERISTICS**

| Characteristic  | Symbol          | Value        | Unit |
|---|-----------------|--------------|------|
| Maximum Instantaneous Forward Voltage Drop (Note 4)<br>(I <sub>F</sub> = 5.0 A, T <sub>J</sub> = 25°C)<br>(I <sub>F</sub> = 5.0 A, T <sub>J</sub> = 150°C)    | V <sub>F</sub>  | 1.15<br>0.98 | V    |
| Maximum Instantaneous Reverse Current (Note 4)<br>( $V_R = 520 \text{ V}, T_J = 25^{\circ}\text{C}$ )<br>( $V_R = 520 \text{ V}, T_J = 150^{\circ}\text{C}$ ) | I <sub>R</sub>  | 5.0<br>400   | μΑ   |
| Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 A, di/dt = 50 A/ $\mu$ s, V <sub>R</sub> = 30 V, T <sub>J</sub> = 25°C)                                   | t <sub>rr</sub> | 95           | ns   |

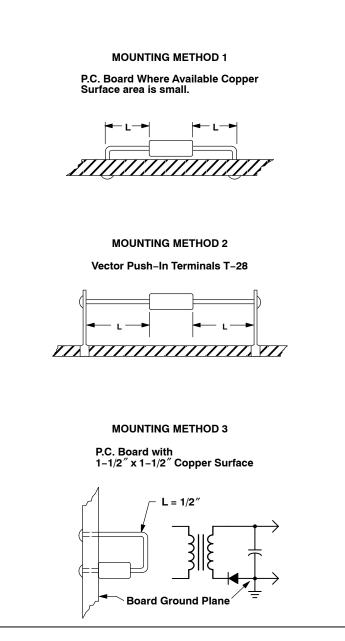
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

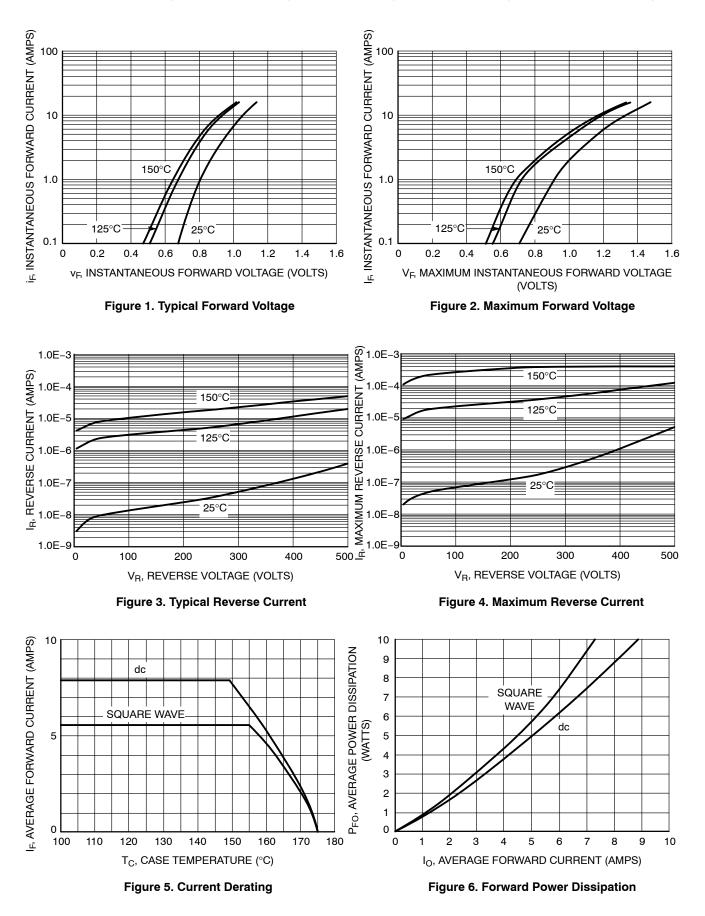
#### NOTE 2 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

#### TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JA}}$ IN STILL AIR

| Mounting<br>Method |                  | Lead Length, L (IN) |     |     |     |       |
|--------------------|------------------|---------------------|-----|-----|-----|-------|
|                    |                  | 1/8                 | 1/4 | 1/2 | 3/4 | Units |
| 1                  |                  | 50                  | 51  | 53  | 55  | °C/W  |
| 2                  | R <sub>0JA</sub> | 58                  | 59  | 61  | 63  | °C/W  |
| 3                  |                  |                     | 28  |     |     | °C/W  |





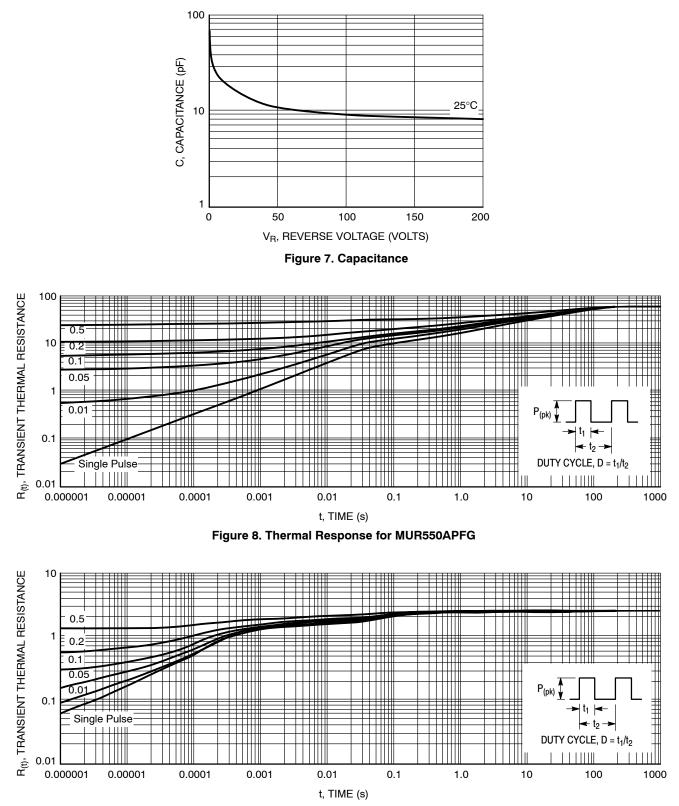
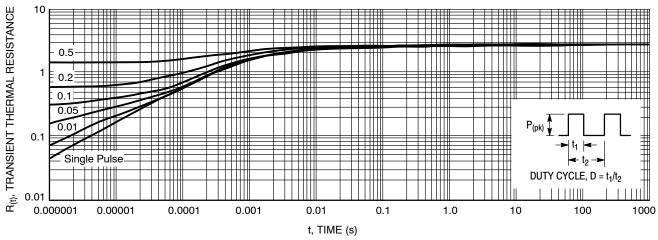


Figure 9. Thermal Response for MURD550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01





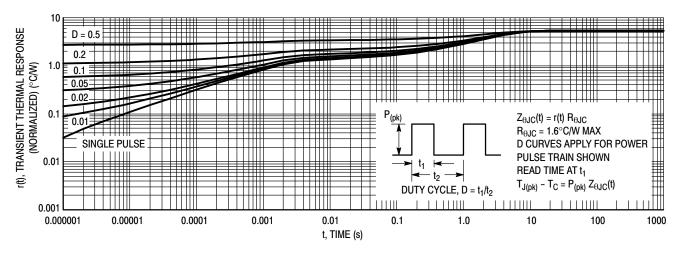


Figure 11. Thermal Response, (MURF550PFG) Junction-to-Case ( $R_{\theta JC}$ )

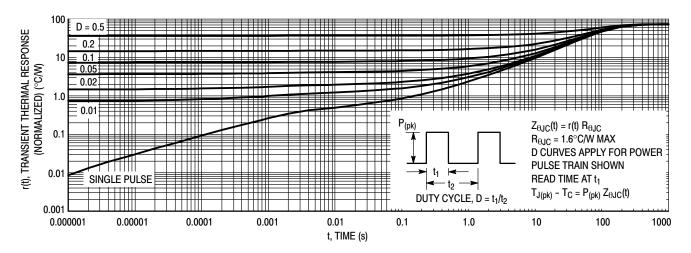
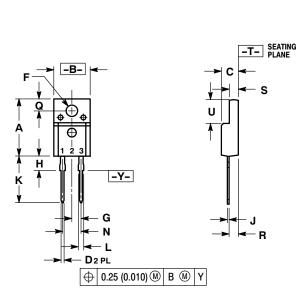


Figure 12. Thermal Response, (MURF550PFG) Junction-to-Ambient ( $R_{\theta JA}$ )









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|---|-------|-------|--------|--------|--|
|   | INC   | HES   | MILLIN | IETERS |  |
| DIM   | MIN   | MAX   | MIN    | MAX    |  |
| Α   | 0.617 | 0.633 | 15.67  | 16.07  |  |
| В   | 0.392 | 0.408 | 9.96   | 10.36  |  |
| C   | 0.177 | 0.193 | 4.50   | 4.90   |  |
| D   | 0.024 | 0.039 | 0.60   | 1.00   |  |
| F   | 0.121 | 0.129 | 3.08   | 3.28   |  |
| G   | 0.100 | BSC   | 2.54   | BSC    |  |
| н   | 0.117 | 0.133 | 2.98   | 3.38   |  |
| J   | 0.018 | 0.025 | 0.45   | 0.64   |  |
| K   | 0.499 | 0.562 | 12.68  | 14.27  |  |
| L   | 0.045 | 0.060 | 1.14   | 1.52   |  |
| N   | 0.200 | BSC   | 5.08   | BSC    |  |
| Q   | 0.122 | 0.138 | 3.10   | 3.50   |  |
| R   | 0.101 | 0.117 | 2.56   | 2.96   |  |
| S   | 0.092 | 0.108 | 2.34   | 2.74   |  |
| U   | 0.255 | 0.271 | 6.48   | 6.88   |  |
| STYLE 1:<br>PIN 1. CATHODE<br>2. N/A<br>3. ANODE  |       |       |        |        |  |

GENERIC MARKING DIAGRAM\*



| А      | = Assembly Location   |
|--------|-----------------------|
| Υ      | = Year                |
| WW     | = Work Week           |
| G      | = Pb-Free Package     |
| XXXXXX | = Device Code         |
| KA     | = Polarity Designator |

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present.

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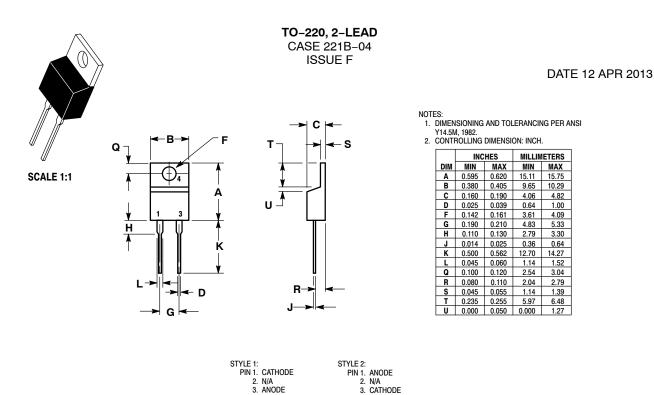
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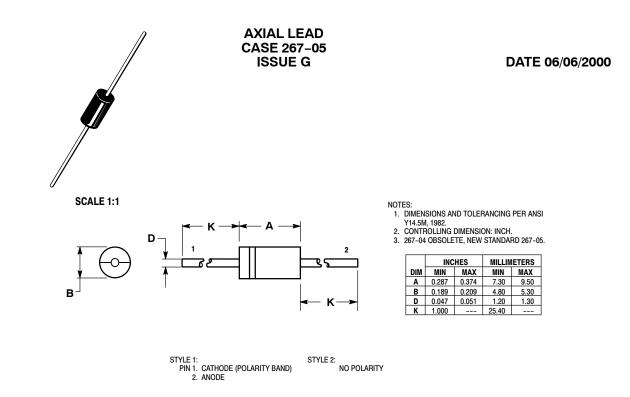
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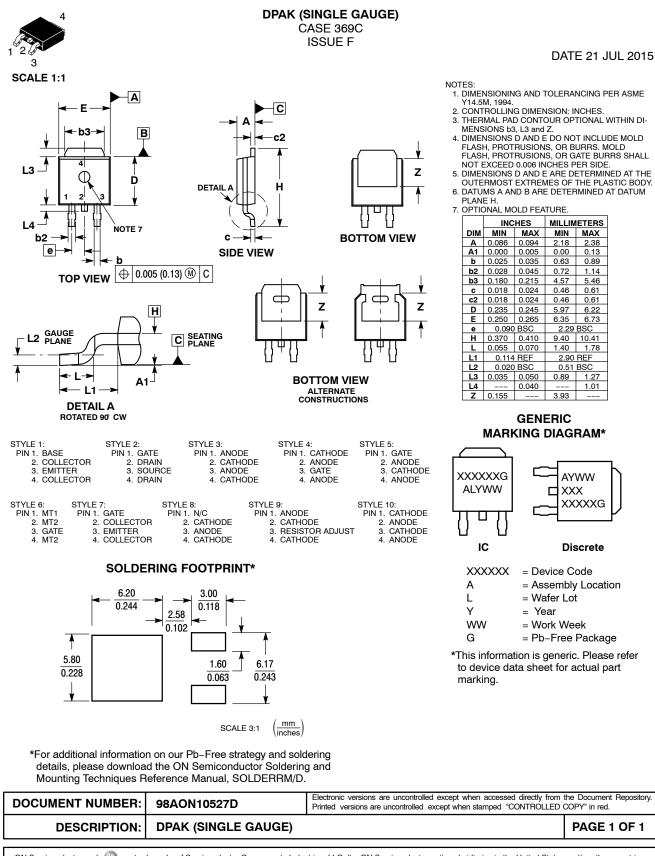




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